



**MODEL:** HSS09-B20-P431 | **DESCRIPTION:** HEAT SINK

**FEATURES**

- TO-220 package
- solder pin
- aluminum alloy
- black anodized finish



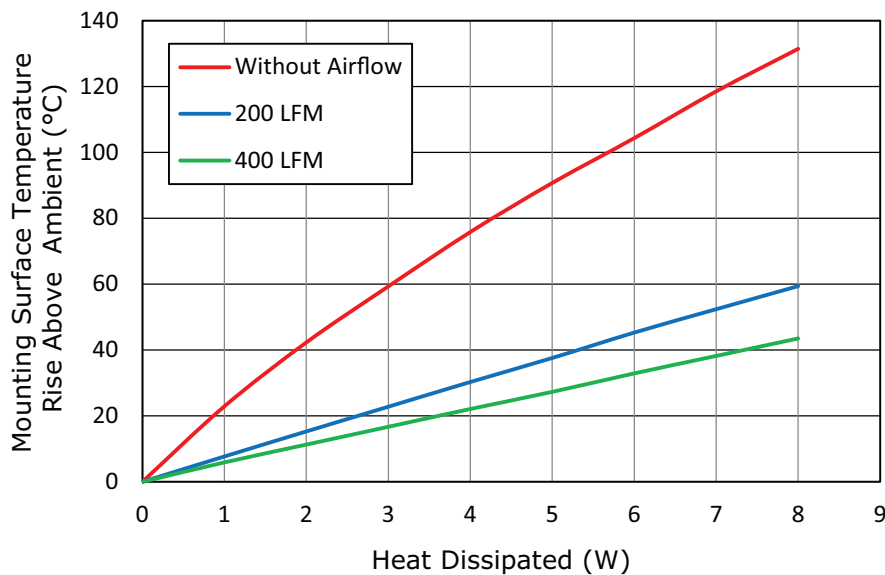
**MODEL**

HSS09-B20-P431	thermal resistance <sup>1</sup>				power dissipation <sup>1</sup>
	@ 75°C ΔT, nat conv [°C/W]	@ 1 W, nat conv [°C/W]	@ 1 W, 200 LFM [°C/W]	@ 1 W, 400 LFM [°C/W]	@ 75°C ΔT, nat conv [W]
	18.82	22.9	7.7	5.9	3.98

Note: 1. See performance curves for full thermal resistance details.

**PERFORMANCE CURVES**

Power (W)	Heatsink Temperature Rise Above Ambient (ΔT = T <sub>hs</sub> - T <sub>a</sub> ) [°C]		
	Natural Conv.	200 LFM	400 LFM
0	0	0	0
1	22.9	7.7	5.9
2	42.3	15.3	11.3
3	59.3	22.8	16.7
4	75.8	30.3	22.1
5	90.7	37.6	27.3
6	104.3	45.3	32.9
7	118.5	52.6	38.2
8	131.4	59.4	43.5



T<sub>hs</sub>: "hot spot" temperature measured on the heatsink  
 T<sub>a</sub>: ambient temperature

## MECHANICAL DRAWING

units: mm  
tolerance: ±0.38 mm

MATERIAL	AL 1050
FINISH	black anodized
THICKNESS	1.2 mm
PIN MATERIAL	brass
PIN PLATING	2-3 μm tin
WEIGHT	5.0 g

